

IN THE  
**United States Patent and Trademark Office**

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**Applicant(s):** Kazumitsu Seki, et al.

**Docket No.:** 17314-018

**Serial No.:** 10/599,661

**Art Unit:** 4116

**Filed:** October 4, 2006

**Examiner:** Chen, Yu

**For:** Palladium-Plated Lead Finishing Structure For Semiconductor Part And Method  
Of Producing Semiconductor Device

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Mailstop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT AND RESPONSE**

Further to the Non-Final Office Action dated February 26, 2009 (hereinafter "Office Action"), in view of the following amendments and/or remarks, Applicants request entry thereof and reconsideration of the above-referenced application.

**Amendments to the Drawings** are discussed beginning on page 2 and are included as a Replacement Sheet in Attachment A.

**Amendments to the Claims** are included starting on page 3.

A **Remarks** section is included starting on page 5.